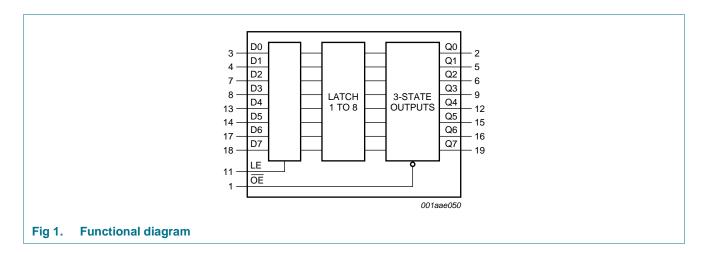
Octal D-type transparent latch; 3-state

3. Ordering information

Table 1. Orc	lering information			
Type number	Package			
	Temperature range	Name	Description	Version
74HC373N	–40 °C to +125 °C	DIP20	plastic dual in-line package; 20 leads (300 mil)	SOT146-1
74HCT373N				
74HC373D	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads;	SOT163-1
74HCT373D			body width 7.5 mm	SOT220 4
74HC373DB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads;	SOT339-1
74HCT373DB			body width 5.3 mm	
74HC373PW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads;	SOT360-1
74HCT373PW			body width 4.4 mm	
74HC373BQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very	SOT764-1
74HCT373BQ			thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	

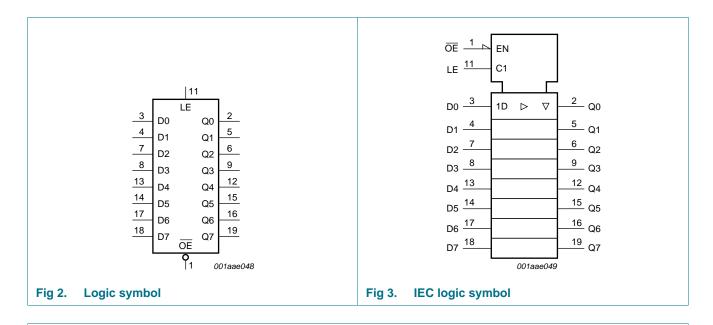
4. Functional diagram



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Octal D-type transparent latch; 3-state



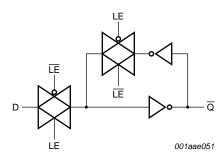
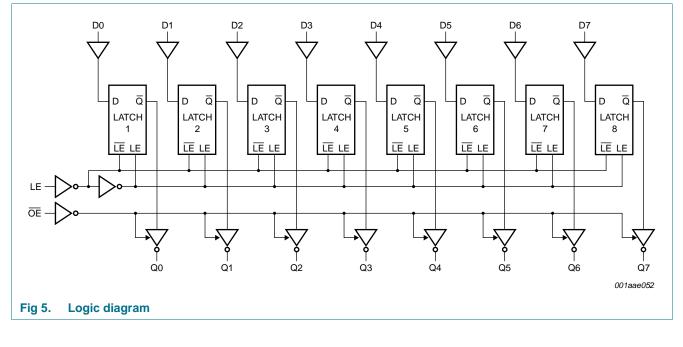


Fig 4. Logic diagram (one latch)



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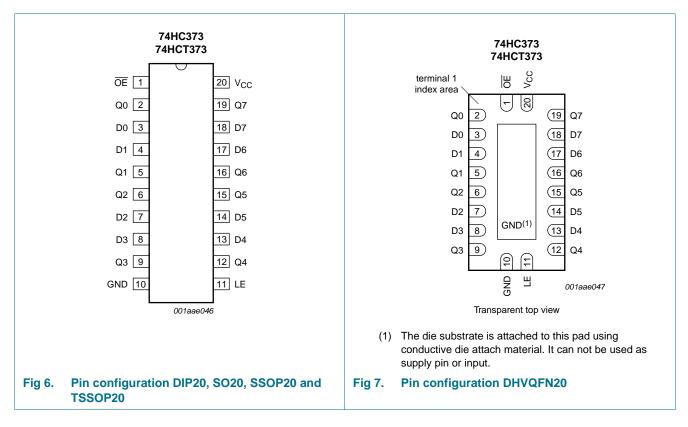
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Octal D-type transparent latch; 3-state

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description		
Symbol	Pin	Description
OE	1	3-state output enable input (active LOW)
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	2, 5, 6, 9, 12, 15, 16, 19	3-state latch output
D0, D1, D2, D3, D4, D5, D6, D7	3, 4, 7, 8, 13, 14, 17, 18	data input
GND	10	ground (0 V)
LE	11	latch enable input (active HIGH)
V _{cc}	20	supply voltage

Octal D-type transparent latch; 3-state

6. Functional description

6.1 Function table

Table 3.Function table^[1]

Operating mode	Control		Input	Internal latches	Output
	OE	LE	Dn		Qn
Enable and read register	L	Н	L	L	L
(transparent mode)			Н	Н	Н
Latch and read register	L	L	I	L	L
			h	Н	Н
Latch register and disable outputs	Н	Х	Х	Х	Z

[1] H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the HIGH-to-LOW LE transition;

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the HIGH-to-LOW LE transition;

X = don't care;

Z = high-impedance OFF-state.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	$V_{\rm I}$ < –0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	-	±20	mA
I _{OK}	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	-	±20	mA
lo	output current	$V_{O} = -0.5 \text{ V}$ to ($V_{CC} + 0.5 \text{ V}$)	-	±35	mA
I _{CC}	supply current		-	+70	mA
I _{GND}	ground current		-	-70	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation				
		DIP20 package	<u>[1]</u> _	750	mW
		SO20 package	[2] _	500	mW
		SSOP20 package	[3]	500	mW
		TSSOP20 package	[3]	500	mW
		DHVQFN20 package	<u>[4]</u> _	500	mW

[1] For DIP20 package: P_{tot} derates linearly with 12 mW/K above 70 °C.

[2] For SO20: P_{tot} derates linearly with 8 mW/K above 70 $^\circ\text{C}.$

[3] For SSOP20 and TSSOP20 packages: P_{tot} derates linearly with 5.5 mW/K above 60 $^\circ$ C.

[4] For DHVQFN20 package: Ptot derates linearly with 4.5 mW/K above 60 °C.

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8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	-	74HC373	3	7	4HCT37	3	Unit
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V_{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V

9. Static characteristics

Table 6. Static characteristics 74HC373

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 25	°C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 2.0 V$	1.5	1.2	-	V
		V _{CC} = 4.5 V	3.15	2.4	-	V
		$V_{CC} = 6.0 V$	4.2	3.2	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 2.0 V$	-	0.8	0.5	V
		V _{CC} = 4.5 V	-	2.1	1.35	V
		$V_{CC} = 6.0 V$	-	2.8	1.8	V
V _{он}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$	-	-	-	
		$I_0 = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	V
		$I_0 = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	V
		$I_0 = -6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	V
		$I_0 = -7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0	0.1	V
		$I_0 = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	0	0.1	V
		$I_{O} = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	V
		$I_0 = 7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	V
lı	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	μA
I _{OZ}	OFF-state output current	$V_I = V_{IH} \text{ or } V_{IL}; V_{CC} = 6.0 \text{ V};$ $V_O = V_{CC} \text{ or GND}$	-	-	±0.5	μΑ
lcc	supply current	$V_{CC} = 6.0 \text{ V}; I_O = 0 \text{ A};$ $V_I = V_{CC} \text{ or GND}$	-	-	8.0	μΑ
CI	input capacitance		-	3.5	-	pF
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Octal D-type transparent latch; 3-state

Symbol	Parameter	Conditions	Min	Тур	Max	Uni
T _{amb} = -4	0 °C to +85 °C					
VIH	HIGH-level input voltage	$V_{CC} = 2.0 V$	1.5	-	-	V
		$V_{CC} = 4.5 V$	3.15	-	-	V
		$V_{CC} = 6.0 V$	4.2	-	-	V
VIL	LOW-level input voltage	$V_{CC} = 2.0 V$	-	-	0.5	V
		$V_{CC} = 4.5 V$	-	-	1.35	V
		$V_{CC} = 6.0 V$	-	-	1.8	V
V _{он}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	-	-	V
		I_{O} = -20 μ A; V_{CC} = 4.5 V	4.4	-	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	-	-	V
		$I_{O} = -6.0 \text{ mA}; \text{ V}_{CC} = 4.5 \text{ V}$	3.84	-	-	V
		$I_{O} = -7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.34	-	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	-	0.1	V
		$I_0 = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	-	0.1	V
		$I_0 = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.33	V
		I_0 = 7.8 mA; V_{CC} = 6.0 V	-	-	0.33	V
l	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 6.0$ V	-	-	±1.0	μA
oz	OFF-state output current	$V_I = V_{IH} \text{ or } V_{IL}; V_{CC} = 6.0 \text{ V};$ $V_O = V_{CC} \text{ or GND}$	-	-	±5.0	μΑ
lcc	supply current	V_{CC} = 6.0 V; I _O = 0 A; V _I = V _{CC} or GND		-	80	μA
T _{amb} = -4	0 °C to +125 °C					
V _{IH}	HIGH-level input voltage	$V_{CC} = 2.0 V$	1.5	-	-	V
		V _{CC} = 4.5 V	3.15	-	-	V
		$V_{CC} = 6.0 V$	4.2	-	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 2.0 V$	-	-	0.5	V
		$V_{CC} = 4.5 V$	-	-	1.35	V V V V V V V μ Α μ Α V V V V
		$V_{CC} = 6.0 V$	-	-	1.8	V
V _{он}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
-		$I_0 = -20 \ \mu\text{A}; \ V_{CC} = 2.0 \ \text{V}$	1.9	-	-	V
		$I_0 = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	-	-	V
		$I_0 = -20 \ \mu\text{A}; \ V_{CC} = 6.0 \ \text{V}$	5.9	-	-	V
		$I_0 = -6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.7	-	-	V
		$I_{\rm O} = -7.8$ mA; $V_{\rm CC} = 6.0$ V	5.2	-	-	V

Table 6. Static characteristics 74HC373 ...continued

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	-	0.1	V
		$I_O = 20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	-	-	0.1	V
		$I_0 = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	-	0.1	V
		$I_{O} = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.4	V
		I_{O} = 7.8 mA; V_{CC} = 6.0 V	-	-	0.4	V
l _l	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±1.0	μA
I _{OZ}	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 6.0 \text{ V};$ $V_{O} = V_{CC} \text{ or GND}$	-	-	±10.0	μA
I _{CC}	supply current	$V_{CC} = 6.0 \text{ V}; I_O = 0 \text{ A};$ $V_I = V_{CC} \text{ or GND}$	-	-	160	μΑ

Table 6. Static characteristics 74HC373 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Table 7. Static characteristics 74HCT373

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 25	°C					
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	V
V _{OH}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_O = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	4.5	-	V
		I_{O} = -6.0 mA; V_{CC} = 4.5 V	3.98	4.32	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	0.0	0.1	V
		I_{O} = 6.0 mA; V_{CC} = 4.5 V	-	0.16	0.26	V
I _I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±0.1	μΑ
I _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 5.5$ V; $V_O = V_{CC}$ or GND per input pin; other inputs at V_{CC} or GND; $I_O = 0$ A	-	-	±0.5	μΑ
I _{CC}	supply current	$V_I = V_{CC} \text{ or GND}; I_O = 0 \text{ A};$ $V_{CC} = 5.5 \text{ V}$	-	-	8.0	μΑ
ΔI_{CC}	additional supply current	$V_I = V_{CC} - 2.1 V;$ other inputs at V_{CC} or GND; $V_{CC} = 4.5 V$ to 5.5 V; $I_O = 0 A$				
		Dn	-	30	108	μΑ
		LE	-	150	540	μΑ
		OE	-	100	360	μA
CI	input capacitance		-	3.5	-	pF
T _{amb} = -4	0 °C to +85 °C					
V _{IH}	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	-	-	V
V _{IL}	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	-	0.8	V

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{он}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_{O} = -20 \ \mu\text{A}; \ V_{CC} = 4.5 \ \text{V}$	4.4	-	-	V
		$I_{O} = -6.0 \ \mu A; \ V_{CC} = 4.5 \ V$	3.84	-	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	-	0.1	V
		$I_{O} = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.33	V
l _l	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±1.0	μA
I _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 5.5$ V; $V_O = V_{CC}$ or GND per input pin; other inputs at V_{CC} or GND; $I_O = 0$ A	-	-	±5.0	μA
I _{CC}	supply current	$V_I = V_{CC} \text{ or GND}; I_O = 0 \text{ A};$ $V_{CC} = 5.5 \text{ V}$	-	-	80	μΑ
ΔI _{CC}	additional supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} - 2.1 \; V;\\ \text{other inputs at } V_{CC} \; \text{or GND};\\ V_{CC} = 4.5 \; V \; \text{to } 5.5 \; V; \; I_{O} = 0 \; A \end{array}$				
		Dn	-	-	135	μA
		LE	-	-	675	μA
		OE	-	-	450	μΑ
T _{amb} = -4	0 °C to +125 °C					
VIH	HIGH-level input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	-	-	V
VIL	LOW-level input voltage	V_{CC} = 4.5 V to 5.5 V	-	-	0.8	V
V _{он}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		I_O = –20 $\mu\text{A};V_{CC}$ = 4.5 V	4.4	-	-	V
		I_O = -6.0 mA; V_{CC} = 4.5 V	3.7	-	-	V
V _{OL}	LOW-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$				
		$I_0 = 20 \ \mu A; \ V_{CC} = 4.5 \ V$	-	-	0.1	V
		$I_{O} = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.4	V
l _l	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±1.0	μΑ
I _{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 5.5$ V; $V_O = V_{CC}$ or GND per input pin; other inputs at V_{CC} or GND; $I_O = 0$ A	-	-	±10	μA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	160	μA
∆l _{CC}	additional supply current	$V_{I} = V_{CC} - 2.1 \text{ V};$ other inputs at V _{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V; I _O = 0 A				
		Dn	-	-	147	μA
		LE	-	-	735	μA
		ŌĒ	-	-	490	μA

Table 7. Static characteristics 74HCT373 ... continued

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Octal D-type transparent latch; 3-state

10. Dynamic characteristics

Table 8. **Dynamic characteristics 74HC373**

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
amb = 2	5 °C					
bd	propagation delay	Dn to Qn; see Figure 8	<u>[1]</u>			
		$V_{CC} = 2.0 V$	-	41	150	ns
		$V_{CC} = 4.5 V$	-	15	30	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	12	-	ns
		$V_{CC} = 6.0 V$	-	12	26	ns
		LE to Qn; see Figure 9				
		$V_{CC} = 2.0 V$	-	50	175	ns
		$V_{CC} = 4.5 V$	-	18	35	ns
		$V_{CC} = 5 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$	-	15	-	ns
		$V_{CC} = 6.0 V$	-	14	30	ns
n	enable time	OE to Qn; see Figure 10	[2]			
		$V_{CC} = 2.0 V$	-	44	150	ns
		$V_{CC} = 4.5 V$	-	16	30	ns
		$V_{CC} = 6.0 V$	-	13	26	ns
dis	disable time	OE to Qn; see Figure 10	[3]			
		$V_{CC} = 2.0 V$	-	47	150	ns
		$V_{CC} = 4.5 V$	-	17	30	ns
		$V_{CC} = 6.0 V$	-	14	26	ns
	transition time	Qn; see Figure 8 and Figure 9	[4]			
		$V_{CC} = 2.0 V$	-	14	60	ns
		$V_{CC} = 4.5 V$	-	5	12	ns
		$V_{CC} = 6.0 V$	-	4	10	ns
V	pulse width	LE HIGH; see Figure 9				
		$V_{CC} = 2.0 V$	80	17	-	ns
		$V_{CC} = 4.5 V$	16	6	-	ns
		$V_{CC} = 6.0 V$	14	5	-	ns
u	set-up time	Dn to LE; see Figure 11				
		$V_{CC} = 2.0 V$	50	14	-	ns ns ns ns ns ns ns ns ns ns ns ns ns n
		$V_{CC} = 4.5 V$	10	5	-	ns
		$V_{CC} = 6.0 V$	9	4	-	ns
1	hold time	Dn to LE; see Figure 11				
		$V_{CC} = 2.0 V$	+5	-8	-	ns
		$V_{CC} = 4.5 V$	+5	-3	-	ns
		$V_{\rm CC} = 6.0 \ V$	+5	-2	-	ns
PD	power dissipation capacitance	per latch; $V_1 = GND$ to V_{CC}	<u>[5]</u>	45	-	pF

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Octal D-type transparent latch; 3-state

Unit

ns

5

5

5

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Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 12. Symbol Parameter Conditions Min Тур Max T_{amb} = -40 °C to +85 °C [1] Dn to Qn; see Figure 8 propagation delay t_{pd} $V_{CC} = 2.0 V$ -190 - $V_{CC} = 4.5 V$ 38 -- $V_{CC} = 6.0 V$ -33 _ LE to Qn; see Figure 9 $V_{CC} = 2.0 V$ 220 -- $V_{CC} = 4.5 V$ 44 _ - $V_{CC} = 6.0 V$ -37 enable time OE to Qn; see Figure 10 [2] t_{en} $V_{CC} = 2.0 V$ 190 _ - $V_{CC} = 4.5 V$ 38 -- $V_{CC} = 6.0 V$ -33 -OE to Qn; see Figure 10 [3] disable time t_{dis} $V_{CC} = 2.0 V$ 190 -- $V_{CC} = 4.5 V$ 38 -- $V_{CC} = 6.0 V$ 33 _ -Qn; see Figure 8 and Figure 9 [4] transition time tt $V_{CC} = 2.0 V$ 75 -- $V_{CC} = 4.5 V$ 15 -- $V_{CC} = 6.0 V$ _ -13 LE HIGH; see Figure 9 pulse width tw $V_{CC} = 2.0 V$ 100 -- $V_{CC} = 4.5 V$ 20 -- $V_{CC} = 6.0 V$ 17 --Dn to LE; see Figure 11 set-up time t_{su} $V_{CC} = 2.0 V$ 65 -- $V_{CC} = 4.5 V$ 13 -- $V_{CC} = 6.0 V$ 11 -hold time Dn to LE; see Figure 11 t_h

Table 8. Dynamic characteristics 74HC373 ... continued

 $V_{CC} = 2.0 V$

 $V_{CC} = 4.5 V$

 $V_{CC} = 6.0 V$

Octal D-type transparent latch; 3-state

Table 8. Dynamic characteristics 74HC373 ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = -	-40 °C to +125 °C					
t _{pd}	propagation delay	Dn to Qn; see Figure 8	[1]			
		$V_{CC} = 2.0 V$	-	-	225	ns
		$V_{CC} = 4.5 V$	-	-	45	ns
		$V_{CC} = 6.0 V$	-	-	38	ns
		LE to Qn; see Figure 9				
		$V_{CC} = 2.0 V$	-	-	265	ns
		$V_{CC} = 4.5 V$	-	-	53	ns
		$V_{CC} = 6.0 V$	-	-	45	ns
en	enable time	OE to Qn; see Figure 10	[2]			
		$V_{CC} = 2.0 V$	-	-	225	ns
		$V_{CC} = 4.5 V$	-	-	45	ns
		$V_{CC} = 6.0 V$	-	-	38	ns
t _{dis}	disable time	OE to Qn; see Figure 10	[3]			
		$V_{CC} = 2.0 V$	-	-	225	ns
		$V_{CC} = 4.5 V$	-	-	45	ns
		$V_{CC} = 6.0 V$	-	-	38	ns
t	transition time	Qn; see Figure 8 and Figure 9	<u>[4]</u>			
		$V_{CC} = 2.0 V$	-	-	90	ns
		$V_{CC} = 4.5 V$	-	-	18	ns
		$V_{CC} = 6.0 V$	-	-	15	ns
W	pulse width	LE HIGH; see Figure 9				
		$V_{CC} = 2.0 V$	120	-	-	ns
		$V_{CC} = 4.5 V$	24	-	-	ns
		$V_{CC} = 6.0 V$	20	-	-	ns
su	set-up time	Dn to LE; see Figure 11				
		$V_{CC} = 2.0 V$	75	-	-	ns
		$V_{CC} = 4.5 V$	15	-	-	ns
		$V_{CC} = 6.0 V$	13	-	-	ns

Octal D-type transparent latch; 3-state

vonages	are relevenced to GN	D (ground = 0 V); $C_L = 50 \text{ pr unless otherwise specified}$		silcult se	e <u>rigure</u>	<u>12</u> .
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _h hold time		Dn to LE; see Figure 11				
	$V_{CC} = 2.0 V$	5	-	-	ns	
	$V_{CC} = 4.5 V$	5	-	-	ns	
		$V_{CC} = 6.0 V$	5	-	-	ns

Table 8. Dynamic characteristics 74HC373 ... continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see Figure 12.

[1] t_{pd} is the same as t_{PLH} and t_{PHL} .

[2] t_{en} is the same as t_{PZH} and t_{PZL} .

[3] t_{dis} is the same as t_{PLZ} and t_{PHZ} .

[4] t_t is the same as t_{THL} and t_{TLH} .

[5] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

$$\begin{split} P_D &= C_{PD} \times V_{CC}{}^2 \times f_i \times N + \sum (C_L \times V_{CC}{}^2 \times f_o) \text{ where:} \\ f_i &= \text{input frequency in MHz;} \\ f_o &= \text{output frequency in MHz;} \\ C_L &= \text{output load capacitance in pF;} \\ V_{CC} &= \text{supply voltage in V;} \\ N &= \text{number of inputs switching;} \end{split}$$

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

Table 9. Dynamic characteristics 74HCT373

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$ unless otherwise specified; for test circuit see <u>Figure 12</u>.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 2	25 °C					
t _{pd}	propagation delay	Dn to Qn; see <u>Figure 8</u>	<u>[1]</u>			
		$V_{CC} = 4.5 V$	-	17	30	ns
		$V_{CC} = 5 \text{ V}; C_{L} = 15 \text{ pF}$	-	14	-	ns
	LE to Qn; see Figure 9					
		$V_{CC} = 4.5 V$	-	16	32	ns
		$V_{CC} = 5 \text{ V}; C_{L} = 15 \text{ pF}$	-	13	-	ns
t _{en}	n enable time	OE to Qn; see Figure 10	[2]			
	$V_{CC} = 4.5 V$	-	19	32	ns	
dis	is disable time	OE to Qn; see Figure 10	[3]			
	$V_{CC} = 4.5 V$	-	18	30	ns	
t	transition time	Qn; see <u>Figure 8</u> and <u>Figure 9</u>	[4]			
		$V_{CC} = 4.5 V$	-	5	12	ns
w	pulse width	LE HIGH; see Figure 9				
		$V_{CC} = 4.5 V$	16	4	-	ns
su	set-up time	Dn to LE; see Figure 11				
		$V_{CC} = 4.5 V$	12	6	-	ns
^t h	hold time	Dn to LE; see Figure 11				
		$V_{CC} = 4.5 V$	4	-1	-	ns
C _{PD}	power dissipation capacitance	per latch; V _I = GND to (V _{CC} – 1.5 V)	<u>[5]</u>	41	-	pF

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
amb = -	40 °C to +85 °C					
pd	propagation delay	Dn to Qn; see Figure 8	<u>[1]</u>			
		$V_{CC} = 4.5 V$	-	-	38	ns
		LE to Qn; see Figure 9				
		$V_{CC} = 4.5 V$	-	-	40	ns
n	enable time	OE to Qn; see Figure 10	[2]			
		$V_{CC} = 4.5 V$	-	-	40	ns
is	disable time	OE to Qn; see Figure 10	[3]			
		$V_{CC} = 4.5 V$	-	-	38	ns
transition time	Qn; see Figure 8 and Figure 9	<u>[4]</u>				
	$V_{CC} = 4.5 V$	-	-	15	ns	
v pulse width	LE HIGH; see Figure 9					
	$V_{CC} = 4.5 V$	20	-	-	ns	
u	set-up time	Dn to LE; see Figure 11				
	$V_{CC} = 4.5 V$	15	-	-	ns	
	hold time	Dn to LE; see Figure 11				
		$V_{CC} = 4.5 V$	4	-	-	ns
amb = -	40 °C to +125 °C					
d	propagation delay	Dn to Qn; see Figure 8	<u>[1]</u>			
		$V_{CC} = 4.5 V$	-	-	45	ns
		LE to Qn; see Figure 9				
		$V_{CC} = 4.5 V$	-	-	48	ns
n	enable time	OE to Qn; see Figure 10	[2]			
		$V_{CC} = 4.5 V$	-	-	48	ns
is	disable time	OE to Qn; see Figure 10	[3]			
		$V_{CC} = 4.5 V$	-	-	45	ns
	transition time	Qn; see Figure 8 and Figure 9	<u>[4]</u>			
		$V_{CC} = 4.5 V$	-	-	18	ns
1	pulse width	LE HIGH; see <u>Figure 9</u>				
		$V_{CC} = 4.5 V$	24	-	-	ns
u	set-up time Dn to LE	Dn to LE; see Figure 11				
- •	$V_{CC} = 4.5 V$	18	-	-	ns	

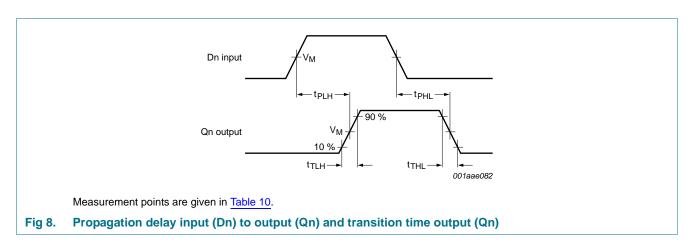
Table 9 Dynamic characteristics 74HCT373 ... continued

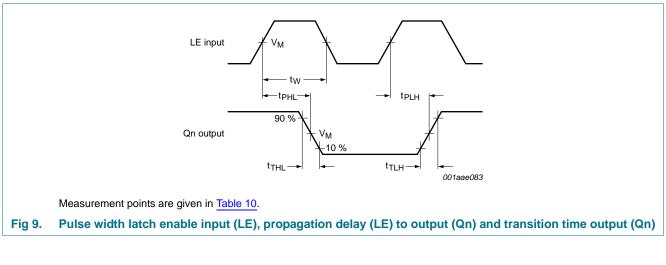
Octal D-type transparent latch; 3-state

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _h	hold time Dn to LE	Dn to LE; see Figure 11				
		$V_{CC} = 4.5 V$	4	-	-	ns
[1] t _{pd} is	the same as t_{PLH} and t_{PHL} .					
[2] t _{en} is	the same as t_{PZH} and t_{PZL} .					
[3] t _{dis} is	the same as t_{PLZ} and t_{PHZ} .					
[4] t _t is t] t _t is the same as t _{THL} and t _{TLH} .					
[5] C _{PD} i	is used to determine the dynamic	power dissipation (P_D in μ W).				
P _D =	$C_{PD} \times {V_{CC}}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}$	$^{2} \times f_{o}$) where:				
$f_i = ir$	nput frequency in MHz;					
$f_0 = c$	output frequency in MHz;					
$C_L =$	output load capacitance in pF;					
V _{CC} :	= supply voltage in V;					
N = r	number of inputs switching;					
$\Sigma(C_{L})$	$\times V_{CC}^2 \times f_0$ = sum of outputs.					

$\Sigma(C_L \times V_{CC}^2 \times f_o) = sum$

11. Waveforms





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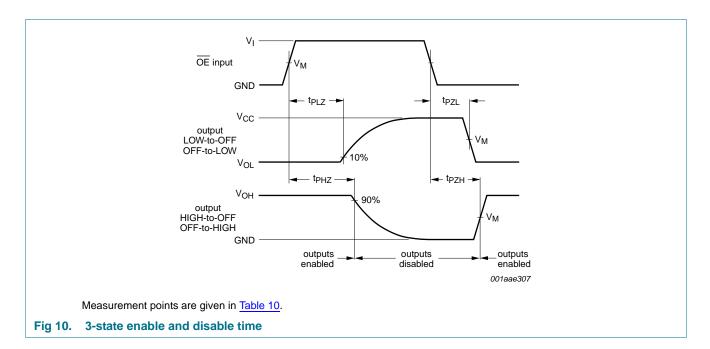
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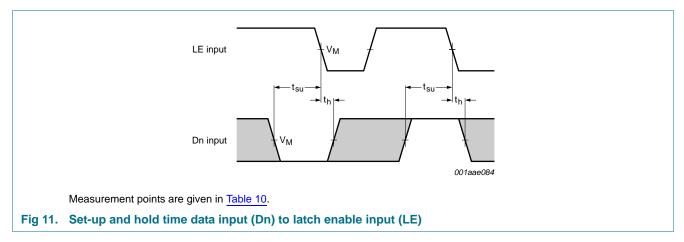


Table 10.Measurement points

Туре	Input	Output
	V _M	V _M
74HC373	0.5V _{CC}	0.5V _{CC}
74HCT373	1.3 V	1.3 V

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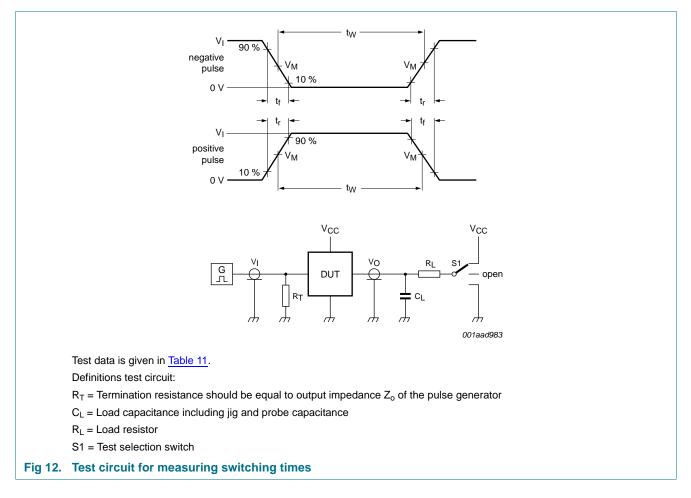


Table 11. Test data

Туре	Input		Load		S1 position		
	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
74HC373	V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}
74HCT373	3 V	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}

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12. Package outline

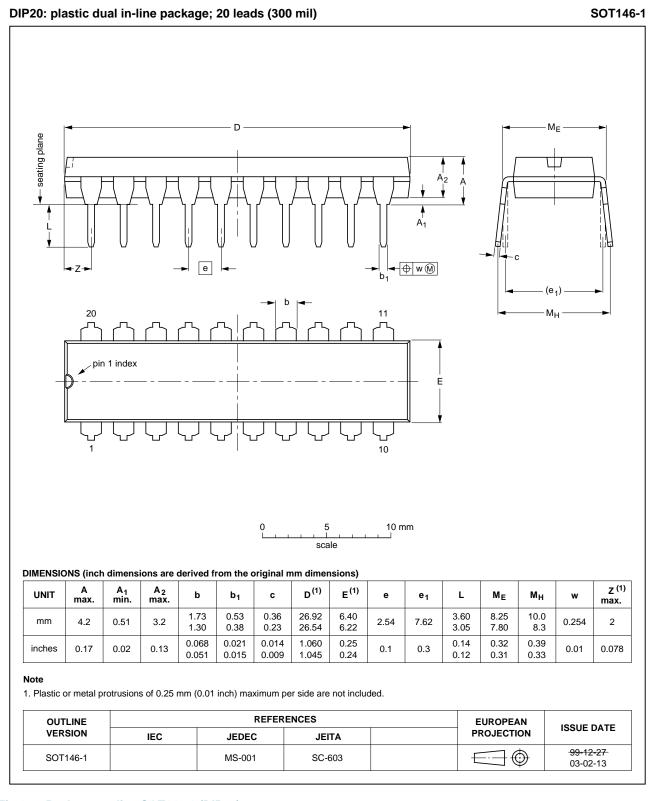


Fig 13. Package outline SOT146-1 (DIP20)

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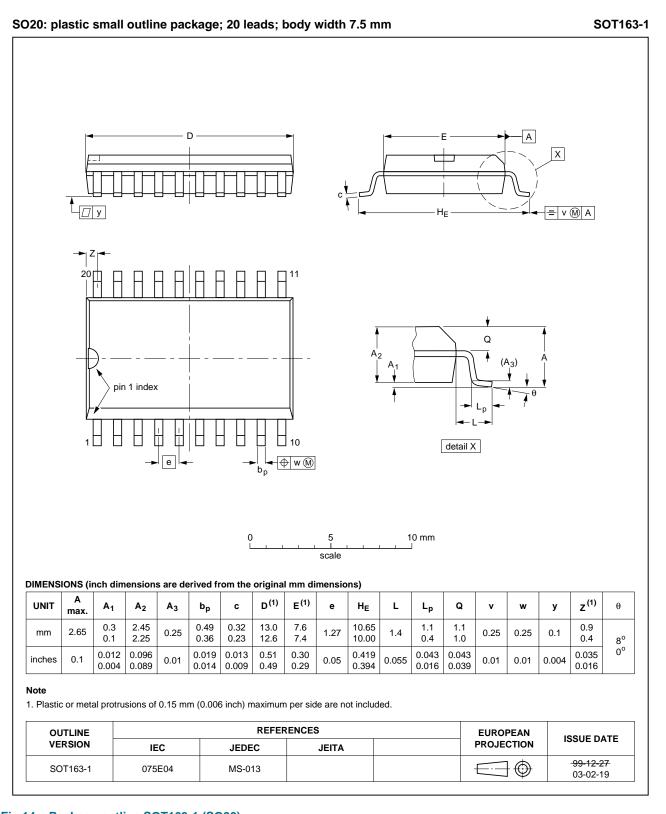


Fig 14. Package outline SOT163-1 (SO20)

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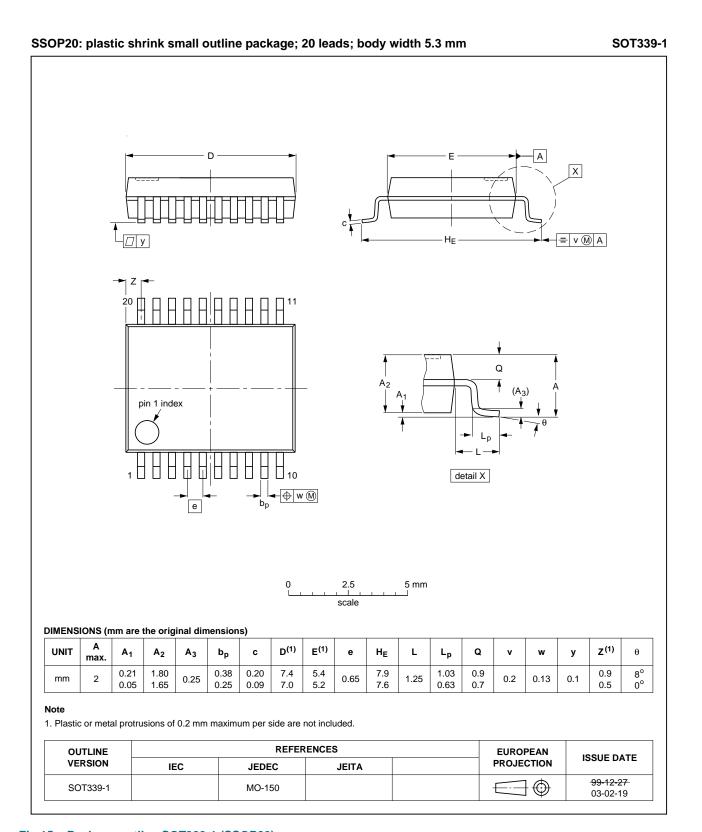


Fig 15. Package outline SOT339-1 (SSOP20)

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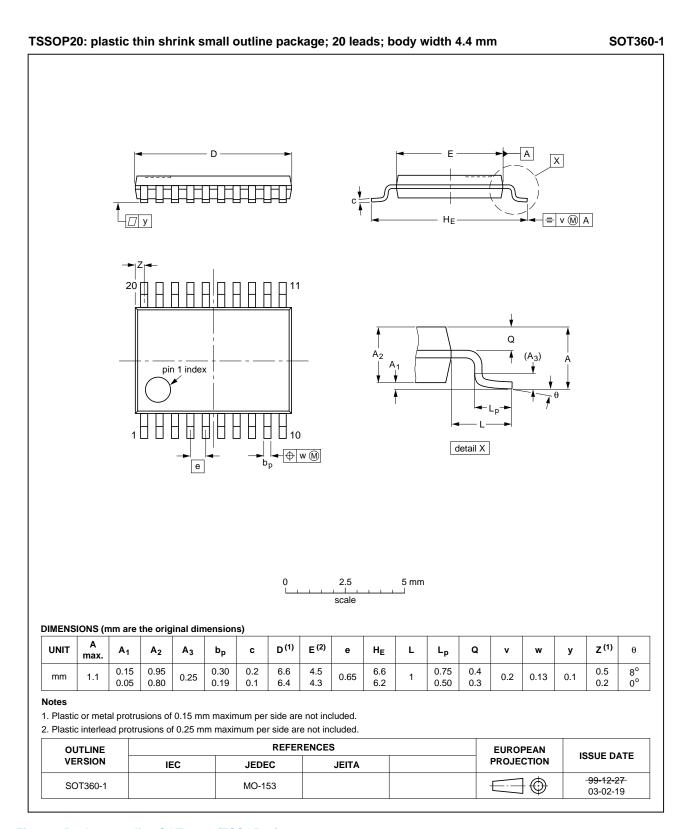
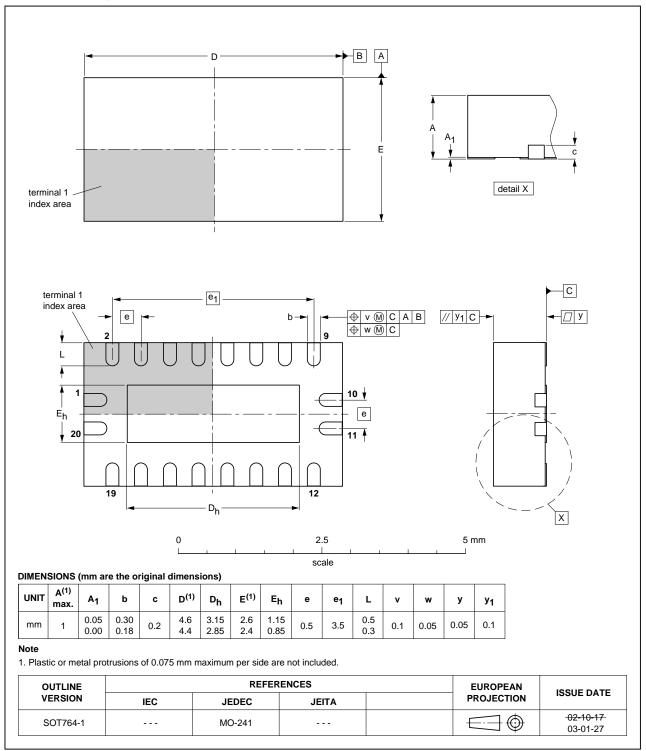


Fig 16. Package outline SOT360-1 (TSSOP20)

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DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 17. Package outline SOT764-1 (DHVQFN20)

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13. Abbreviations

	Abbreviations
Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 13.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT373 v.5	20111213	Product data sheet	-	74HC_HCT373 v.4
Modifications:	 Legal page 	es updated.		
74HC_HCT373 v.4	20100903	Product data sheet	-	74HC_HCT373 v.3
74HC_HCT373 v.3	20060120	Product data sheet	-	74HC_HCT373_CNV v.2
74HC_HCT373_CNV v.2	19970827	Product specification	-	-

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15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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